



VMDSEMI

VFTV010R020NA

Datasheet



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General Description

$V_{(BR)DSS}$	$R_{DS(ON)}_{max}$	I_D
100V	2.0mΩ@10V	325A

Symbol

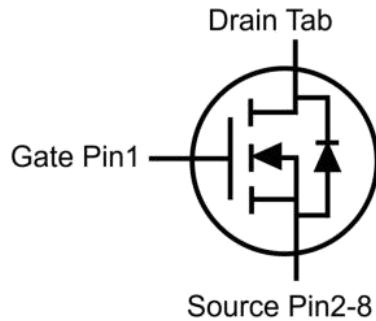


Figure 1 Symbol of VFTV010R020NA

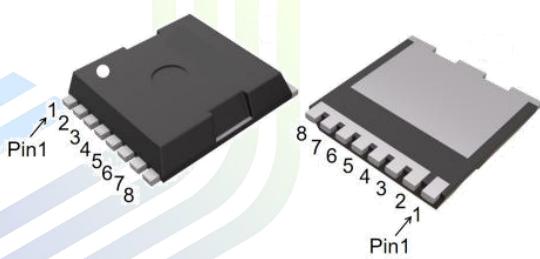
Features

- Low $R_{DS(ON)}$
- 100% Avalanche Tested
- 100% R_g Tested
- Low switching losses

Application

- PD charger
- Motor driver
- Switching voltage regulator
- DC-DC converter
- Switched mode power supply

Package Type



TOLL

Figure 2 Package Type of VFTV010R020NA



Ordering Information

Product Name	Package
VFTV010R020NA	TOLL

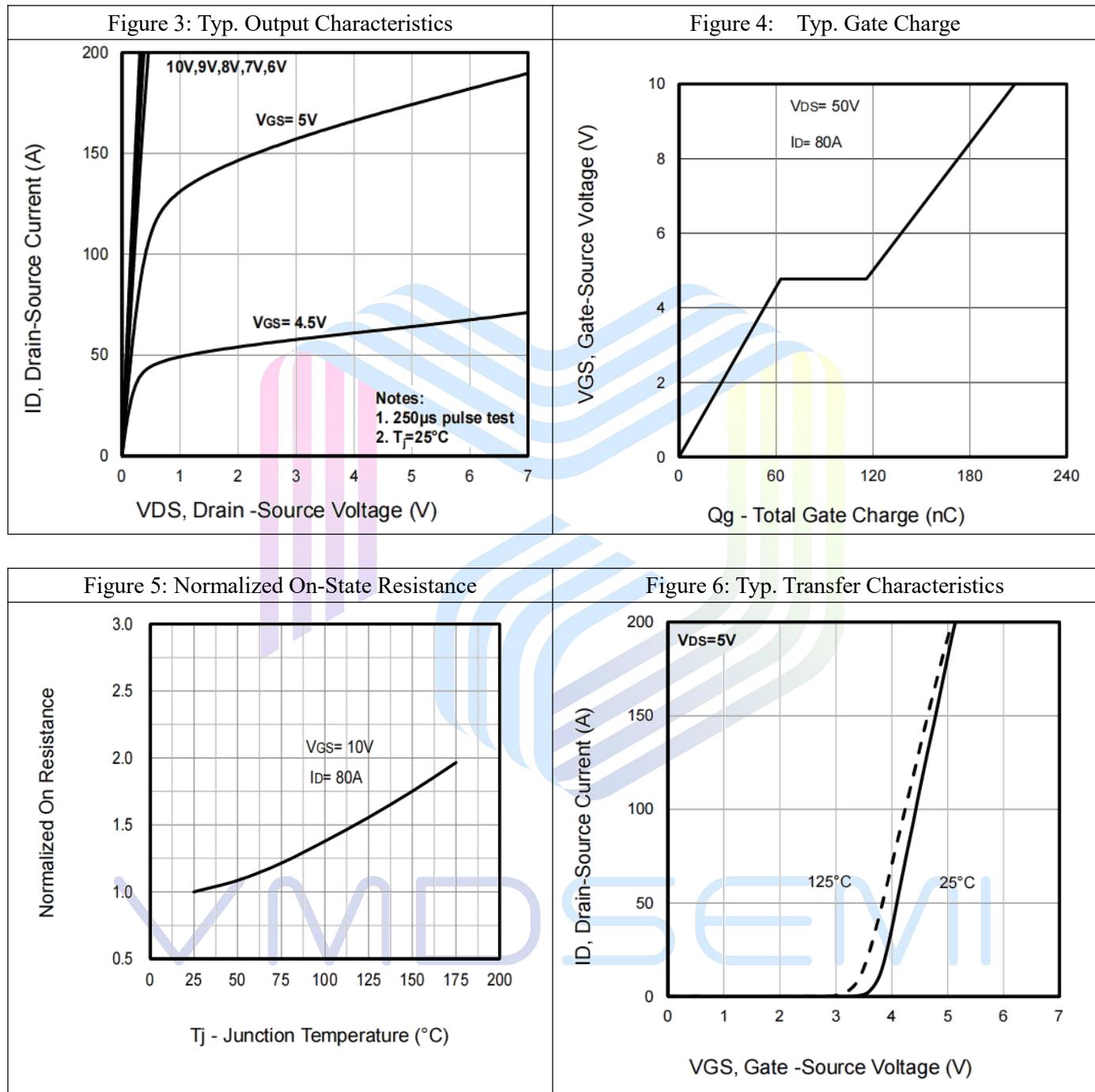
Absolute Maximum Ratings (T_A= 25 °C, unless otherwise specified)

Parameter	Symbol	Rating	Unit	
Drain-Source Voltage	V _{DSS}	100	V	
Gate-Source Voltage	V _{GSS}	±20	V	
Continuous Drain Current (Wire bond limited)	T _C =25°C	I _D	325	A
Continuous Drain Current (Silicon limited)			265	A
Pulsed Drain Current ^{Note 1}	T _C =25°C	I _{D,pulse}	1160	A
Diode Forward Current (Wire bond limited)	T _C =25°C	I _S	325	A
Continuous Drain Current	T _A =25°C	I _{DSM}	28	A
Continuous Drain Current	T _A =70°C		22	A
Max Power Dissipation ^{Note3}	T _C =25°C	P _D	536	W
Max Power Dissipation ^{Note4}	T _A =25°C	P _{DSM}	2.9	W
Avalanche Energy, Single Pulse ^{Note 2}	E _{AS}		2209	mJ
Operation and storage temperature	T _{J,TSTG}		-55 to 175	°C

Thermal Resistance

Parameter	Symbol	Min	Typ	Max	Unit
Thermal Resistance, Junction-to-Case ^{Note5}	R _{θJC}	-	0.23	0.28	°C/W
Thermal Resistance, Junction-to-Ambient ^{Note6}	R _{θJA}	-	36	43	

Typical Performance Characteristics



2.0mΩ, 100V, N-Channel Power MOSFET

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Figure 7: Typical On Resistance vs VGS

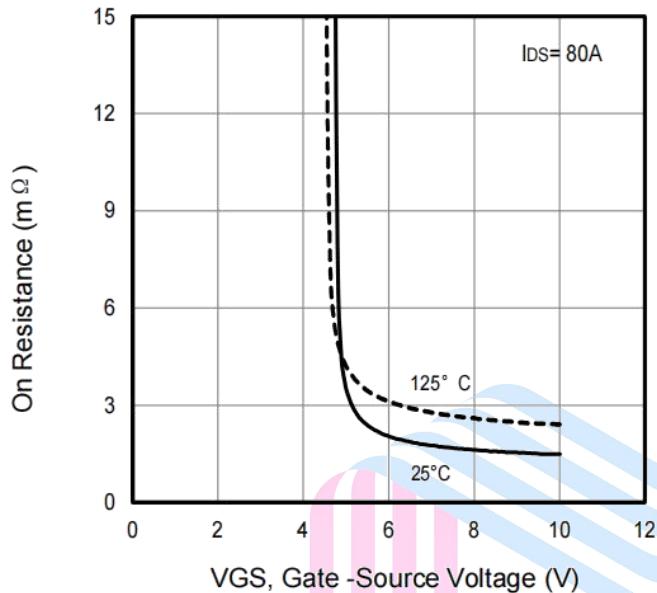


Figure 8: Typical On Resistance vs ID and Gate

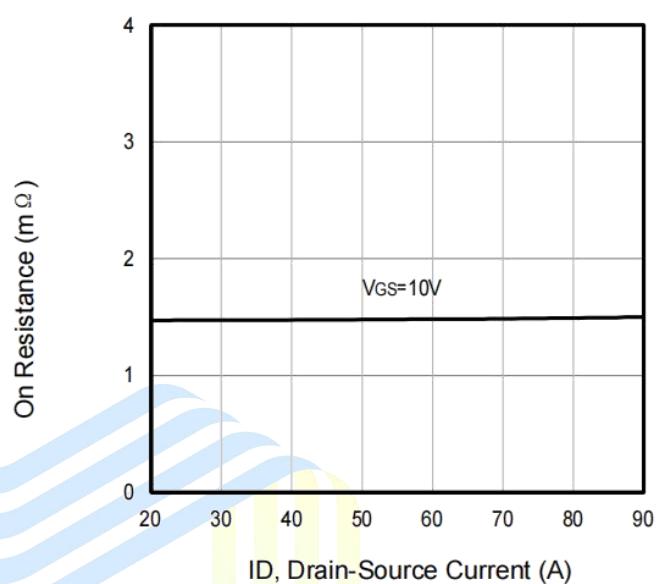


Figure 9: Power Dissipation Vs. Case Temperature

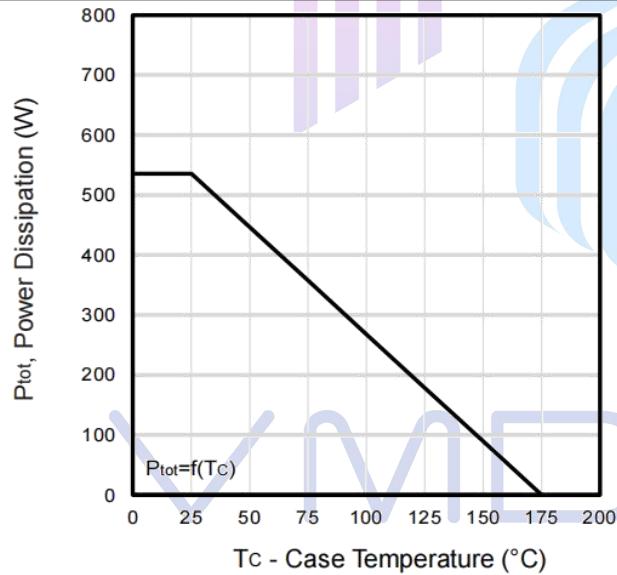
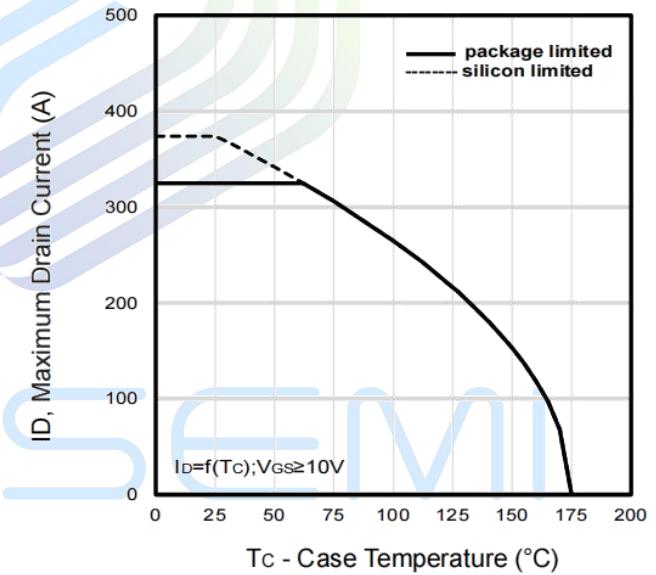


Figure 10: Drain Current Vs. Case Temperature



2.0mΩ, 100V, N-Channel Power MOSFET

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Figure 11: Typ. Capacitances

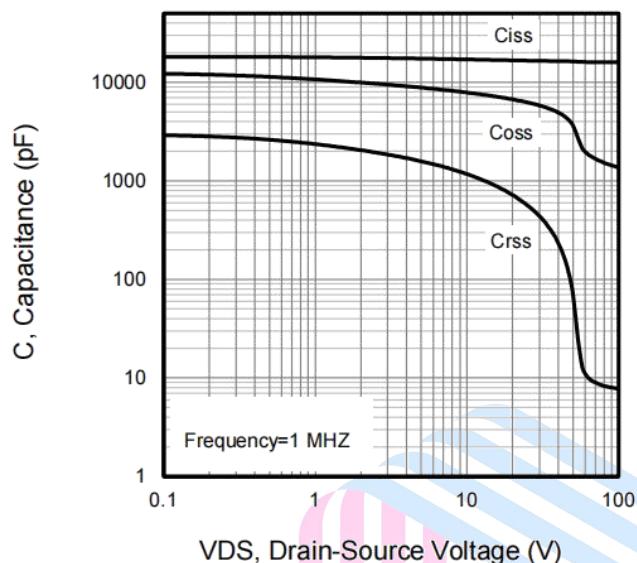


Figure 12: Forward Characteristics of Body Diode

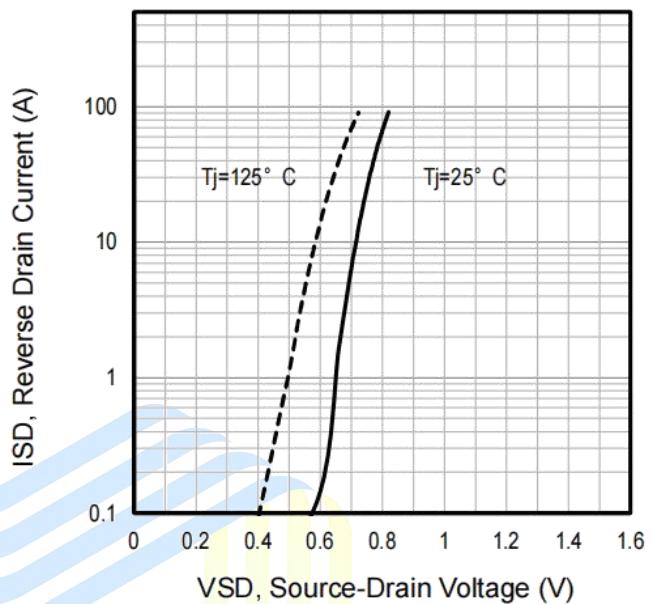


Figure 13: Gate-Source Threshold Voltage

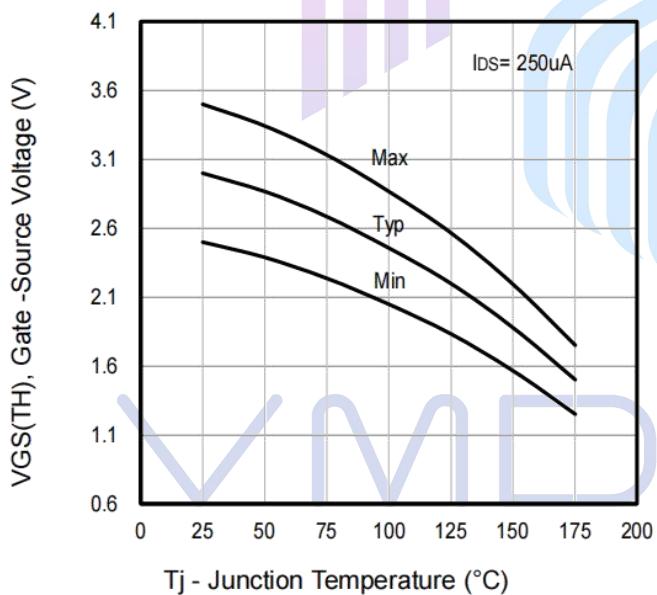


Figure 14: Safe Operating Area

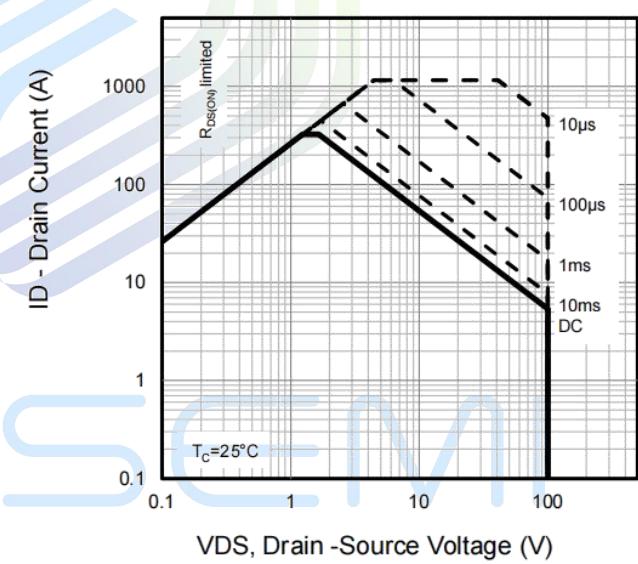
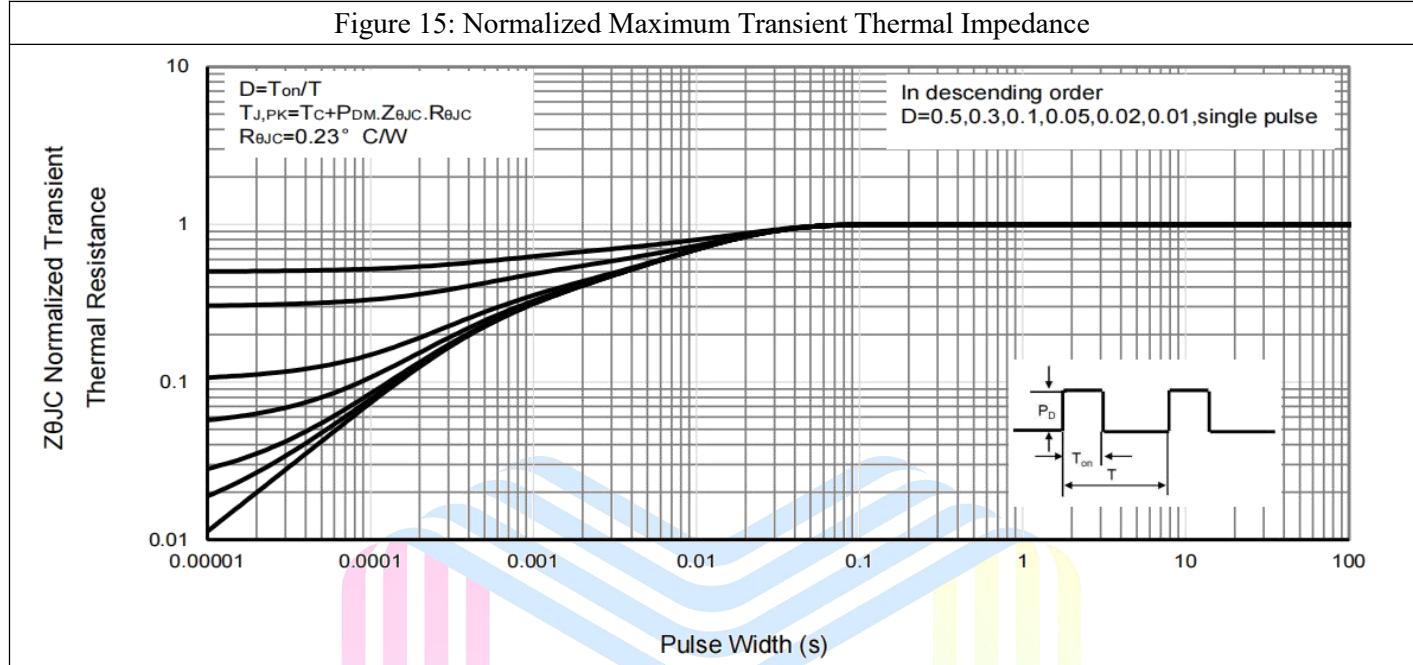


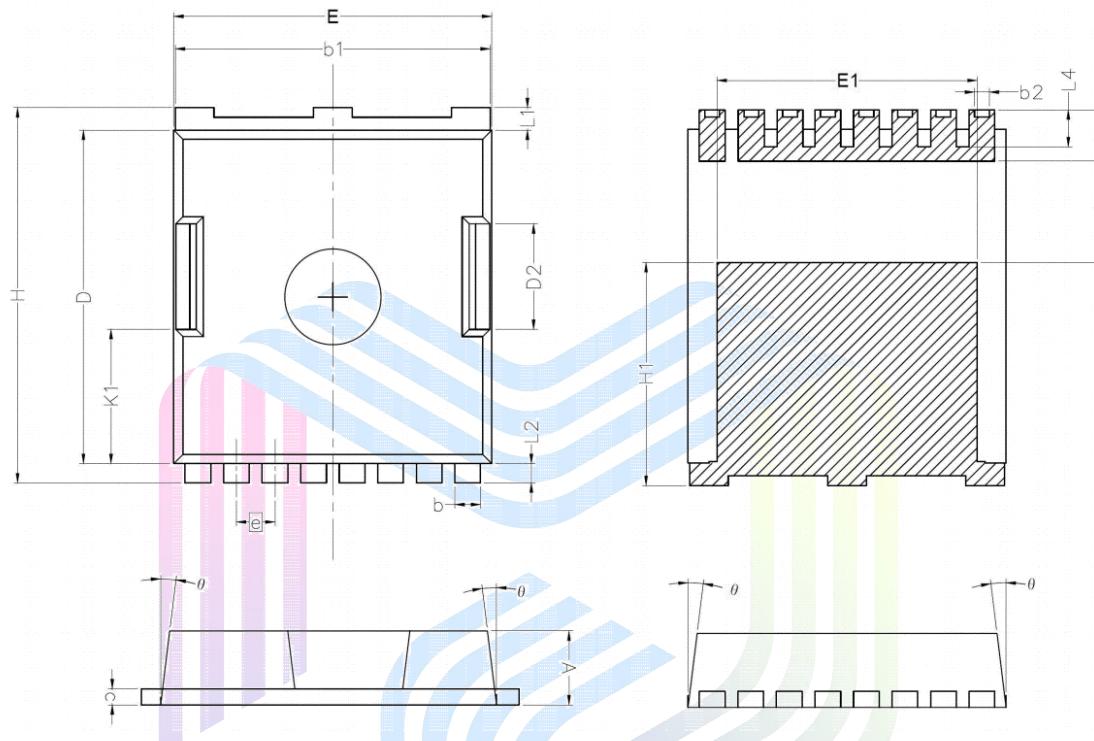
Figure 15: Normalized Maximum Transient Thermal Impedance



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Mechanical Dimensions

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Note:

1. All dimensions are in mm, angles in degrees.
2. Dimensions do not include mold flash protrusions or gate burrs.

Symbol	DIMENSIONS (unit : mm)			Symbol	DIMENSIONS (unit : mm)		
	Min	Typ	Max		Min	Typ	Max
A	2.20	--	2.40	H	11.48	11.68	11.88
b	0.70	--	0.90	H1	6.75	6.95	7.15
b1	9.70	--	9.90	N	--	8	--
b2	0.42	--	0.50	J	3.00	3.15	3.30
c	0.40	--	0.60	K1	3.98	4.18	4.38
D	10.28	--	10.58	L	1.40	1.60	1.80
D2	3.10	3.30	3.50	L1	0.60	0.70	0.80
E	9.70	9.90	10.10	L2	0.50	0.60	0.70
E1	7.90	8.10	8.30	L4	1.00	1.15	1.30
e	1.20BSC			θ	4°	7°	10°

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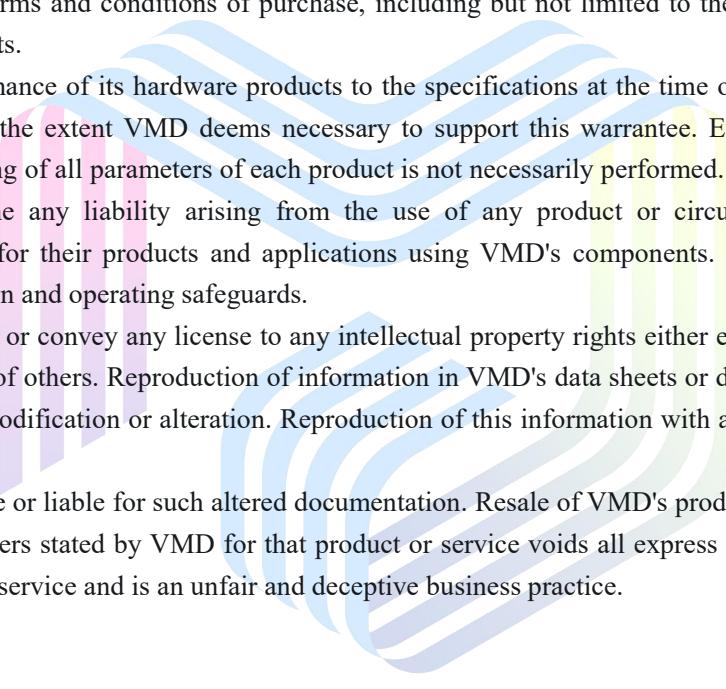
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